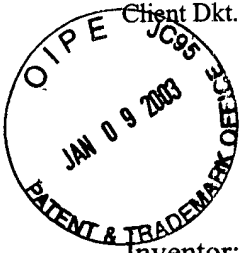


Inventor: Henry Johnson  
Serial No.: 09/752,658  
Client Dkt. No. H0001540 (4960)

Art Unit: 2827  
Examiner: David Graybill



**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE  
WASHINGTON, D.C. 20231**

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Inventor: **Henry Johnson**

Serial No: **09/752,658**

Filed: **December 28, 2000**

For: **Layered Circuit Boards and  
Methods of Production Thereof**

Examiner: David Graybill  
Art Unit: 2827

Client Docket No.: H0001540 (4960)  
Attorney Docket No.: 100665.0021US1

**RESPONSE TO OFFICE ACTION**

Assistant Commissioner for Patents  
Washington, D.C. 20231

Dear Sir:

This paper responds to the Office Action dated October 21, 2002. Please enter the following:

**IN THE CLAIMS**

Amend claim 2 as follows:

2. The sublamination material of claim 1, wherein the material consists essentially of the two signal layers, the reference layer, the cured core material, the cured bond-ply, and the at least one via, and wherein the material is not coupled to any other layers.